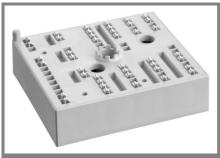
SKiiP 39AHB086V1



MiniSKiiP[®] 2

3-phase bridge rectifier + brake chopper

SKiiP 39AHB086V1

Target Data

Features

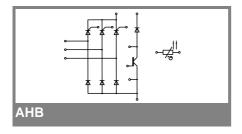
- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connenections
- UL recognised file no. E63532

Typical Applications

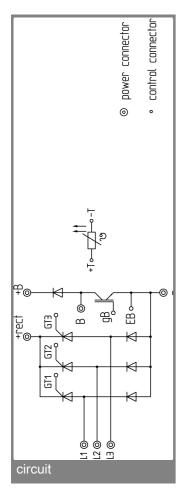
Input bridge for Inverter up to 30 kVA

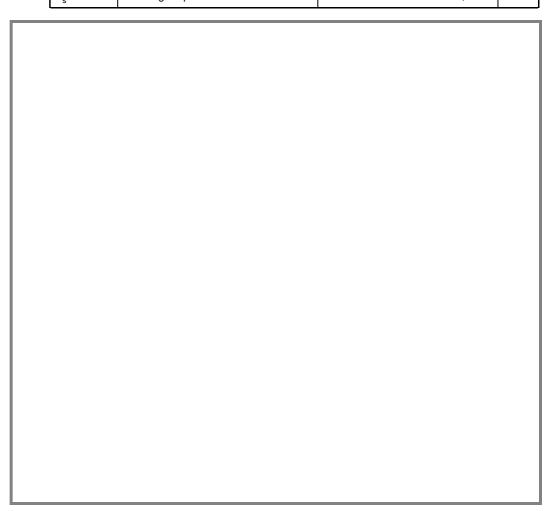
Absolute	Maximum Ratings	T _s = 25 °C, unless otherwise specified						
Symbol	Conditions	Values	Units					
IGBT - Chopper								
V_{CES}		600	V					
I _C	T _s = 25 (70) °C		Α					
I _{CRM}	$T_s = 25 (70) ^{\circ}C, t_p \le 1 \text{ms}$		Α					
V_{GES}		± 15	V					
T_j		- 40 + 150	°C					
Diode - Chopper								
I _F	$T_s = 25 (70) ^{\circ}C$		Α					
I _{FRM}	$T_s = 25 (70) ^{\circ}C, t_p \le 1 \text{ms}$		Α					
T _j	·	- 40 + 150	°C					
Diode / Thyristor - Rectifier								
V_{RRM}		800	V					
I _F / I _T	$T_{s} = 70$	82	Α					
I _{FSM} / I _{TSM}	$t_p = 10 \text{ ms, sin } 180 ^\circ, T_j = 25 ^\circ\text{C}$	1050	Α					
i²t	$t_p = 10 \text{ ms, sin } 180 ^\circ, T_j = 25 ^\circ\text{C}$	5500	A²s					
T _j	Diode	- 40 + 150	°C					
T _j	Thyristor	- 40 + 125	°C					
I _{tRMS}	per power terminal (20 A / spring)	120	Α					
T _{stg}	$T_{op} \le T_{stg}$	- 40 + 125	°C					
V_{isol}	AC, 1 min.	2500	V					

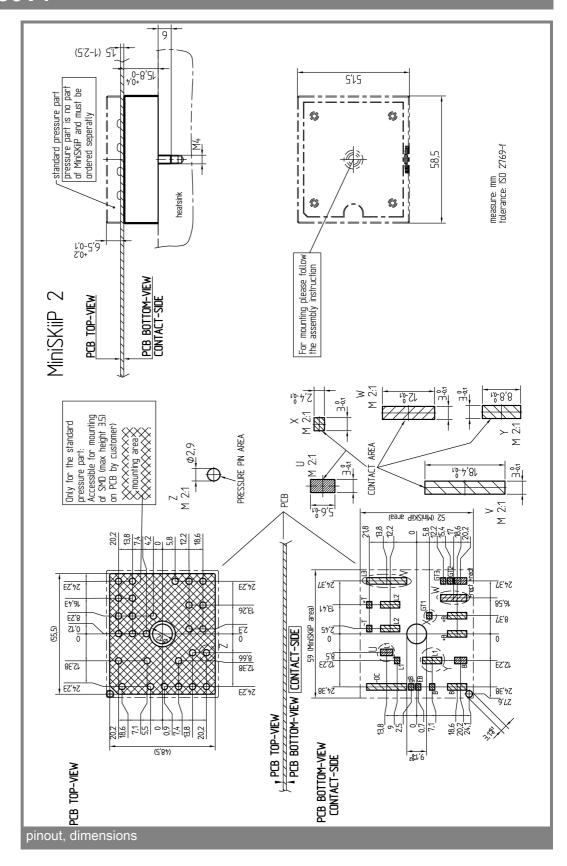
Characteristics		T_s = 25 °C, unless otherwise specified							
Symbol	Conditions	min.	typ.	max.	Units				
IGBT - Chopper									
V_{CEsat}	I _C = 150 A, T _i = 25 (125) °C		2 (2,2)	2,5 (2,7)	V				
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 3 \text{ mA}$	3	4	5	V				
$V_{CE(TO)}$	T _j = 25 (125) °C		1,2 (1,1)	1,3 (1,2)	V				
r _T	$T_j = 25 (125) ^{\circ}C$		5,3 (7,3)	8 (10)	mΩ				
C _{ies}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		9		nF				
C _{oes}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		1,7		nF nF				
C _{res}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		2,1						
$R_{th(j-s)}$	per IGBT		0,4		K/W				
t _{d(on)}	under following conditions		20		ns				
t _r `´	$V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}$		25		ns				
$t_{d(off)}$	$I_C = 150 \text{ A}, T_j = 125 ^{\circ}\text{C}$		185		ns				
t _f	$R_{Gon} = R_{Goff} = 4 \Omega$		15		ns				
E _{on}	inductive load		5,7						
E _{off}			3,7		mJ				
Diode - C	Diode - Chopper								
$V_F = V_{EC}$	I _F = 150 A, T _j = 25 (125) °C		1,7 (1,7)	2,1 (2,1)	V				
V _(TO)	T _i = 25 (125) °C		1 (0,9)	1,1 (1)	V				
r _T	$T_j = 25 (125) ^{\circ}C$		4,7 (5,3)	6,7 (7,3)	mΩ				
$R_{th(j-s)}$	per diode		0,55		K/W				
I _{RRM}	under following conditions		270		Α				
Q _{rr}	I _F = 150 A, V _R = 300 V		18		μC				
E _{rr}	$V_{GE} = 0 \text{ V}, T_j = 125 ^{\circ}\text{C}$		3,5		mJ				
	di _F /dt = 13700 A/μs								



Characteristics		T _s = 25 °C, unless otherwise specified						
Symbol	Conditions	min. typ	o. max.	Units				
Diode - Rectifier								
V_{F}	I _F = 75 A, T _i = 25 °C	1,2		V				
V _(TO)	$T_j = 150 ^{\circ}\text{C}$	0,8		V				
r _T	T _j = 150 °C	7		mΩ				
$R_{th(j-s)}$	per diode	0,7		K/W				
Thyristor - Rectifier								
V_T	I _F = 120 A, T _j = 25 (125) °C		1,8 (1,7)	V				
$V_{T(TO)}$	T _i = 125 °C		1,1	V				
r _T	$T_{j} = 125 ^{\circ}\text{C}$		5	mΩ				
V _{GT}	T _j = 25 °C		3	V				
I _{GT}	T _j = 25 °C	150		mA				
I _H	T _j = 25 °C	200		mA				
I _L	T _j = 25 °C	400)	mA				
dv/dt _(cr)	T _j = 125 °C		1000	V/µs				
di/dt _(cr)	T _j = 125 °C		50	A/µs				
$R_{th(j-s)}$	per thyristor	0,65	5	K/W				
	Temperature Sensor							
R _{ts}	3 %, T _r = 25 (100) °C	1000(1	670)	Ω				
Mechanic	Mechanical Data							
w		65		g				
M_s	Mounting torque	2	2,5	Nm				







This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

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